Wi-Fi®/ Bluetooth® Modules



Wi-Fi® + Bluetooth® MCU modules

Type 1JP/1JQ

PN: LBWA1ZZ1JP-928 PN: LBWA1ZZ1JQ-171 TI CC3100/CC3200 Chipset 13.2 x 21.45 x 2.65mm



6802.11 b/g/n + ARM Cortex- M3

FCC/IC/CE*/Japan Certified

Type 1KP/1KQ/1KR/1KS

PN: LBWA1ZZ1KP-289 PN: LBWA1ZZ1KQ-290 PN: LBWA1ZZ1KR-291 PN: LBWA1ZZ1KS-088 TI CC3120/CC3220 CC3220S/CC3220SF 13.2 x 21.45 x 2.65mm



SimpleLink Gen2 SDK
6802.11 b/g/n

+ ARM Cortex- M3 FCC/IC/CE*/Japan Certified

Wi-Fi® + Bluetooth® modules

Type WT

PN: LBEP5CLWTC-631 WL1801/1831 Chipset 9.9 x 8.8 x1.3 mm -40 ~ 75°C





6802.11 b/g/n + Bluetooth® 4.1

Type WM

PN: LBEP5CLWMC-633 WL1803/1833 Chipset 9.9 x 8.8 x1.3 mm -40 ~ 75°C





6802.11 a/b/g/n + Bluetooth[®] 4.1

Japan Certified

Type XR

PN: LBEP5CLXRC-701 WL1801 Chipset 9.9 x 8.8 x1.3 mm -40 ~ 85°C





6.802.11 b/g/n

